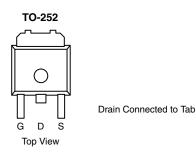


P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
- 100	0.043 at V _{GS} = - 10 V	- 37	54 nC	
- 100	0.048 at V _{GS} = - 4.5 V	- 35	54 110	



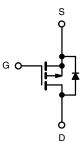
SUD50P10-43L-GE3 (Lead (Pb)-free and Halogen-free)

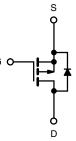
Ordering Information:

FEATURES

- TrenchFET[®] Power MOSFET
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A =$	= 25 °C, unless othe	rwise noted)		-1
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 100	- V
Gate-Source Voltage		V _{GS}	± 20	
	T _C = 25 °C		- 36.4	
	T _C = 70 °C	1 , [- 29.1	
Continuous Drain Current (T _J = 150 °C) ^b	T _A = 25 °C		- 9 ^{b, c}	
	T _A = 70 °C	1	- 7.2 ^{b, c}	А
Pulsed Drain Current	I _{DM}	- 40	- A	
	T _C = 25 °C		- 50 ^a	
Continuous Source Current (Diode Conduction)	T _A = 25 °C	- I _S -	- 5.75 ^{b, c}	1
Avalanche Current		I _{AS}	- 35	
Single Pulse Avalanche Energy	L = 0.1 mH		61	mJ
	T _C = 25 °C		113.6	
Meximum Device Disainstian	T _C = 70 °C		72.7	14/
Maximum Power Dissipation	T _A = 25 °C	P _D —	6.9 ^{b, c}	W
	T _A = 70 °C	1 –	4.4 ^{b, c}	1
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
	Symbol	Typical	Maximum	Unit	
t ≤ 10 s	R _{thJA}	15	18	°C/W	
Steady State		40	50		
	R _{thJC}	0.85	1.1		
		$\begin{tabular}{c} t \leq 10 \ s \\ \hline Steady \ State \end{tabular} R_{thJA} \end{tabular}$	$\begin{array}{c c} t \leq 10 \text{ s} & 15 \\ \hline \text{Steady State} & \text{R}_{\text{thJA}} & 40 \\ \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes:

a. Package limited.

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b. Surface mounted on 1" x 1" FR4 board.

d. Maximum under steady state conditions is 50 °C/W.

For technical questions, contact: pmostechsupport@vishay.com

www.vishay.com

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c. t = 10 s.

SUD50P10-43L-GE3

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		<u> </u>			1	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 100			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050		- 109		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = - 250 μΑ		5.9		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1		- 3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zana Osta Mallana Dusia Osmanl		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	1
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 40			Α
		V _{GS} = - 10 V, I _D = - 9.2 A		0.036	0.043	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 7.7 A		0.040	0.048	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 9.2 A		38		S
Dynamic ^b		·		•		
Input Capacitance	C _{iss}			4600		pF
Output Capacitance	C _{oss}	V _{DS} = - 50 V, V _{GS} = 0 V, f = 1 MHz		230		
Reverse Transfer Capacitance	C _{rss}			175		
Tatal Cata Chauna		$V_{DS} = -50$ V, $V_{GS} = -10$ V, $I_{D} = -9.2$ A		106	160	nC
Total Gate Charge	Qg			54	81	
Gate-Source Charge	Q _{gs}	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_{D} = - 9.2 A		14		
Gate-Drain Charge	Q _{gd}			26		
Gate Resistance	Rg	f = 1 MHz		4		Ω
Turn-On Delay Time	t _{d(on)}			15	25	
Rise Time	t _r	V_{DD} = - 50 V, R_L = 6.5 Ω		20	30	ns
Turn-Off Delay Time	t _{d(off)}	$\rm I_D\cong$ - 7.7 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 1 Ω		110	165	
Fall Time	t _f			100	150	
Turn-On Delay Time	t _{d(on)}			42	65	
Rise Time	t _r	V_{DD} = - 50 V, R_L = 6.5 Ω		160	240	ns
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 7.7 A, V_GEN = - 4.5 V, R_g = 1 Ω		100	150	
Fall Time	t _f			100	150	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			- 50	۸
Pulse Diode Forward Current ^a	I _{SM}				- 40	A
Body Diode Voltage	V _{SD}	I _S = - 7.7 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			60	90	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1 - 770 dt/dt - 1000 dt/dt = 0000 dt/dt		150	225	nC
Reverse Recovery Fall Time	ta	I _F = - 7.7 A, dl/dt = 100 A/μs, T _J = 25 °C		46		
Reverse Recovery Rise Time	t _b	1 1		14		ns

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

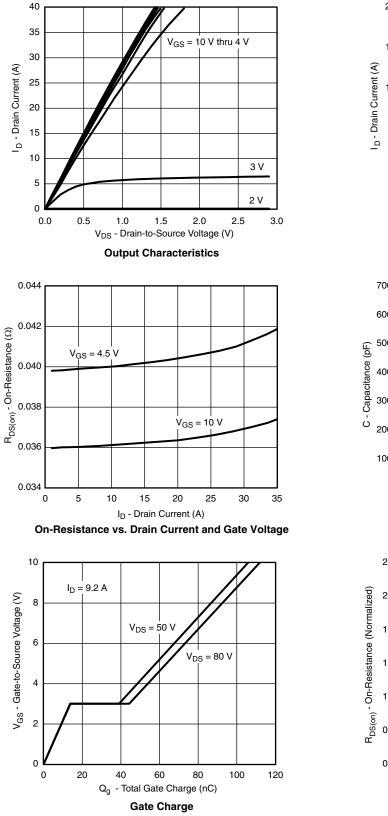
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

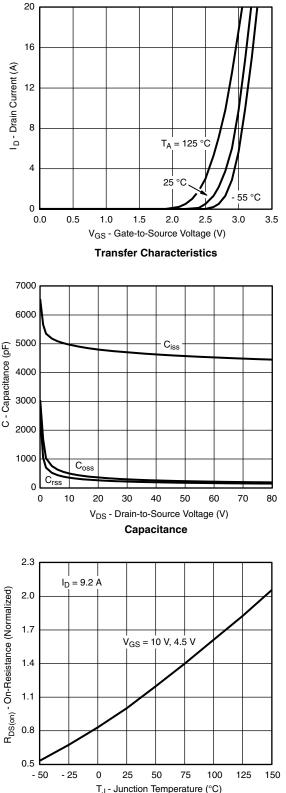


SUD50P10-43L-GE3

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On-Resistance vs. Junction Temperature

Document Number: 62504 S12-1955-Rev. B, 13-Aug-12

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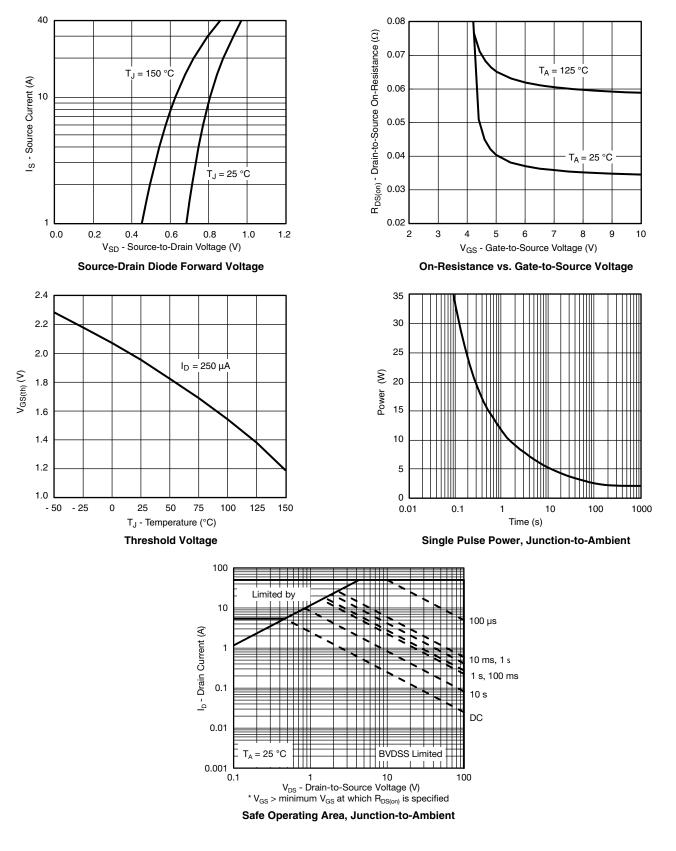
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

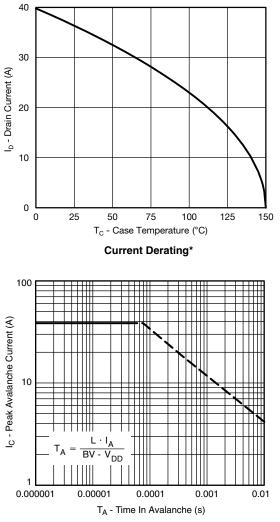


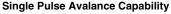


SUD50P10-43L-GE3

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

140

105

70

35

0

0

25

50

75

T_C - Case Temperature (°C)

Single Pulse Power, Junction-to-Ambient

100

125

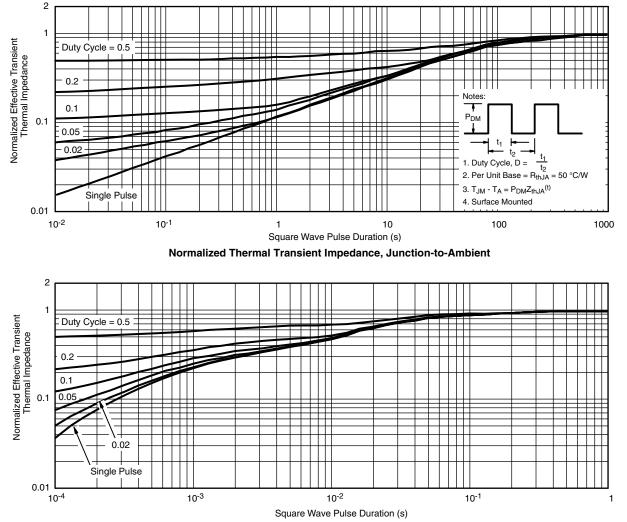
150

Power (W)

VISHAY.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

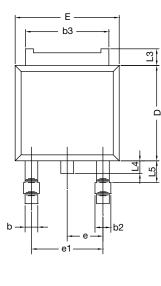
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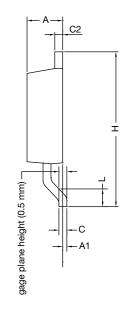


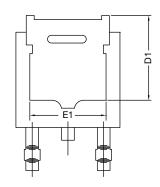


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







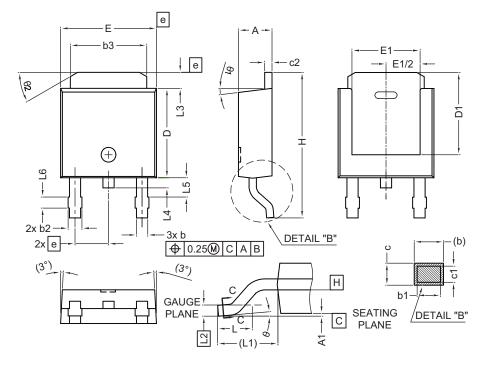
	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0° 15°		
θ2	25° 35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

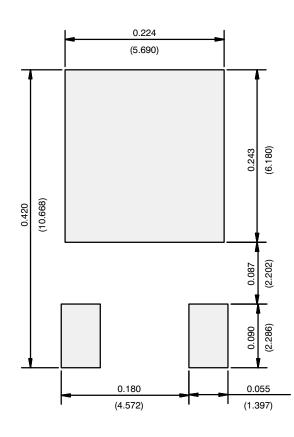
Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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